| ABBOCIATION CONNECTING<br>ELECTRONICE INDUSTRIES® INCLUSTRIES® | PC. Bannockl   | burn. Illinois. A                    | All rights reserved nations. | under both                           | This docume<br>level parts, t  | ent is a declara<br>he declaration               | tion of the s<br>encompass     | substances<br>es all low | s within the<br>er level ma | e manufactur<br>terials for wh  | er listed it hich the m             | em. Note<br>anufactu | : if the item is<br>rer has engine | an assembly<br>ering responsi | with lower<br>bility. |
|--|--|--------------------------------------|------------------------------|--------------------------------------|--|--|--------------------------------|--------------------------|-----------------------------|---------------------------------|-------------------------------------|----------------------|------------------------------------|-------------------------------|-----------------------|
|  |  |                                      |                              | Form Type <sup>5</sup><br>Distribute | <ul> <li>Declaration Class *<br/>Class 6 - RoHS Yes/No, Homogeneous Materials</li> </ul> |  |                                |                          |                             | als and Mi                      | s and Mfg Information               |                      |                                    |                               |                       |
| Supplier Information   |  |                                      |                              |                                      |  |  |                                |                          |                             |                                 |                                     |                      |                                    |                               |                       |
| Company name* Compan   |  |                                      | ompany unique ID             |                                      |  | Unique ID Authority                              |                                |                          |                             |                                 | Response Date*                      |                      |                                    |                               |                       |
| onsemi   |  |                                      |                              |                                      |  |  |                                |                          |                             |                                 | 2024-05-05                          |                      |                                    |                               |                       |
| Contact Name Title - Contact                                   |  |                                      |                              |                                      |  | Phone - Contact*                                 |                                |                          |                             |                                 | Email - Contact*                    |                      |                                    |                               |                       |
| Product-Env-Stewards Produ                                     |  |                                      | Product Enviro Compliance    |                                      |  | NA   |                                |                          |                             | Product-Env-Stewards@onsemi.com |                                     |                      |                                    |                               |                       |
| Authorized Representative* Title                               |  |                                      | Fitle - Representative       |                                      |  | Phone - Representative*                          |                                |                          |                             | Email - Representative*         |                                     |                      |                                    |                               |                       |
| Product-Env-Stewards Prod                                      |  |                                      | Product Enviro Compliance    |                                      |  | NA   |                                |                          |                             | Product-Env-Stewards@onsemi.com |                                     |                      |                                    |                               |                       |
| Requester Item Number  | Requester Item Number Mfr Item                           |                                      | n Number Mfr Item Name       |                                      |  | Effective Dat                                    | ate Version Manufacturing Site |                          | V                           | Veight*                         | UOM                                 | Un                   | it Type                            |                               |                       |
|  | BAS217   | BAS21TMR6T1G 250V HIGH VOLT<br>DIODE |                              | LTAGE SWITCH                         | HING   | 2024-05-05                                       |                                |                          |                             |                                 | 1                                   | 3.43                 | mg                                 | Ead                           | :h                    |
| Manufacturing Proccess Informa                                 | tion   |                                      |                              |                                      |  |  |                                |                          |                             |                                 |                                     |                      |                                    |                               |                       |
| Terminal Plating / Grid Array Ma                               | inal Plating / Grid Array Material Terminal Base Alloy J |                                      |                              | J-STD-020 MSL                        | Rating   | g Peak Process Body Temperature Max Time at Peal |                                |                          |                             |                                 | Temperature Number of Reflow Cycles |                      |                                    |                               |                       |
| Matte Tin (Sn) - annealed CU Alloy                             |  |                                      | 1                            |                                      | 260  |  | С                              | 30                       |                             | second                          | ls 3                                |                      |                                    |                               |                       |
| Comments   |  |                                      |                              |                                      |  |  |                                |                          |                             |                                 |                                     |                      |                                    |                               |                       |
| evel 1 - maximum time at peak temperatu                        | re during so   | Idering is 10-3                      | 30 seconds                   |                                      |  |  |                                |                          |                             |                                 |                                     |                      |                                    |                               |                       |
| or more information regarding material                         | composition  | please refer to                      | page 3                       |                                      |  |  |                                |                          |                             |                                 |                                     |                      |                                    |                               |                       |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *  | Detailed  |
|--|--|--|---|---|---|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  |  | nium (Cr6+), Polybro   | ominated Biphenyls (PBB), Polybron  | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth |   |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe  | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance   | * Accepted  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |
| Declaration Signature  |  |  |   |   |   |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital   | lly sign the declaration (if required by the  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| sigma range of distribution unless | otherwise noted). |                 |          |                              | -          | _      |        | -               |
|------------------------------------|-------------------|-----------------|----------|------------------------------|------------|--------|--------|-----------------|
| Homogeneous Material               | Weight            | Unit of Measure | Level    | Substance                    | CAS        | Exempt | Weight | Unit of Measure |
| Die                                | 0.67              | mg              | Supplier | Silicon (Si)                 | 7440-21-3  |        | 0.67   | mg              |
| Lead Frame 2                       | 2.55              | mg              | В        | Nickel (Ni)                  | 7440-02-0  |        | 0.9664 | mg              |
|                                    |                   |                 | Supplier | Iron (Fe)                    | 7439-89-6  |        | 1.3362 | mg              |
|                                    |                   |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.2473 | mg              |
| Mold Compound-Black                | 10.0              | mg              | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2 |        | 1      | mg              |
|                                    |                   |                 | Supplier | Carbon Black (C)             | 1333-86-4  |        | 0.05   | mg              |
|                                    |                   |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 |        | 1.45   | mg              |
|                                    |                   |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0 |        | 6.5    | mg              |
|                                    |                   |                 | Supplier | Phenolic Resin (Novolac)     | 9003-35-4  |        | 1      | mg              |
| Plating                            | 0.13              | mg              | Supplier | Tin (Sn)                     | 7440-31-5  |        | 0.13   | mg              |
| Wire Bond - Cu                     | 0.08              | mg              | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.08   | mg              |